

INFORMATION DISCLOSURE CITATION
(Page 1 of 2)

Atty. Docket No. BU9-99-055	Serial No.
Applicants: Andres BRYANT et al.	
Filing Date: October 17, 2001	Group:

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Examiner Initial*	Document Number	Date	Name	Class	Sub Class	Filing Date If Appropriate
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*Examiner: AS	6-9-02
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